

C0603C681KATACTU

Aliases (C0603C681KATAC7867)

SMD Comm X8G HT150C, Ceramic, 680 pF, 10%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.5 mm



| General Information | |
|--------------------------|--|
| Series | SMD Comm X8G HT150C |
| Style | SMD Chip |
| Description | SMD, MLCC, High Temperature, Ultra-Stable |
| Features | High Temperature, Ultra-Stable |
| RoHS | Yes |
| Termination | Tin |
| Marking | No |
| AEC-Q200 | No |
| Typical Component Weight | 3.7 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| 0603 |
|------------------|
| 1.6mm +/-0.15mm |
| 0.8mm +/-0.15mm |
| 0.8mm +/-0.07mm |
| 0.5mm MIN |
| 0.35mm +/-0.15mm |
| |

| Packaging Specifications | |
|--------------------------|------------------------|
| Packaging | T&R, 180mm, Paper Tape |
| Packaging Quantity | 4000 |

| Specifications | |
|--|--|
| Capacitance | 680 pF |
| Measurement Condition | 1 MHz 1.0Vrms |
| Tolerance | 10% |
| Voltage DC | 250 VDC |
| Dielectric Withstanding Voltage | 625 VDC |
| Temperature Range | -55/+150°C |
| Temp. Coefficient | X8G |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 30 ppm/C, 1MegaHz 1.0Vrms |
| Dissipation Factor | 0.1% 1 MHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour: Referee Time is 1000 Hours |
| Insulation Resistance | 100 GOhms |

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